

SC70-6 Package Low IQ High Light Load Efficiency Synchronous Boost Converter

■ FEATURES

- Deliver 3.3V at 60mA from a Single Alkaline/Ni-MH or 3.3V at 120mA from Two Cells
- Up to 94% Efficiency
- Low Shutdown Current: <1.0μA
- Low Quiescent Current: 7.5µA
- Low No-load Input Current (see Typical Performance Characteristics for detail)
- Start up Into Load at 0.7V Input Voltage
- Output Disconnect by Shutdown Function
- · Anti-ringing Control for EMI Consideration
- Small SC70-6 Package

APPLICATIONS

- Wireless Mice
- Medical Instruments
- Smart Phones
- Bluetooth Devices

DESCRIPTION

The AlC3411 is a synchronous step-up DC/DC converter. That is based on constant Off Time/PSM controller topology. The IC enters PSM mode automatically at light load, the goal is to improve efficiency and reduce quiescent current. The AlC3411 provide a complete power supply solution for products powered by one or two Alkaline, Ni-Cd, or Ni-MH battery cells. It stays in operation with supply voltages down to 0.7V. The implemented boost converter is based on a constant Off Time/PSM controller topology using an internal synchronous rectifier to obtain maximum efficiency. A low-EMI mode is implemented to reduce ringing and in effect lower radiated electromagnetic energy when the converter enters the discontinuous conduction mode.

■ TYPICAL APPLICATION CIRCUIT

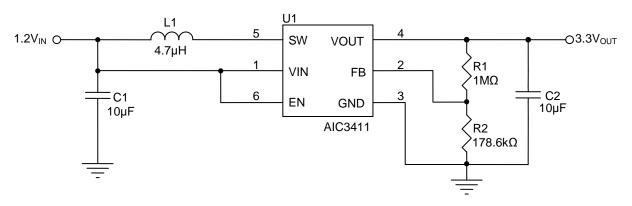
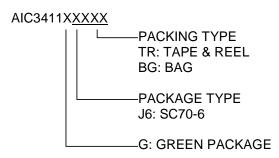


Fig. 1 One Cell Step-Up DC/DC Converter

Analog Integrations Corporation 1A1, 1 Li-Hsin 1st Rd., Science Park , Hsinchu 300, Taiwan , R.O.C.

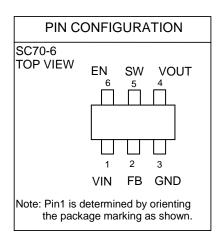


ORDERING INFORMATION



Example: AIC3411GJ6TR

→ In SC70-6 Green Package & Tape & Reel Packing Type



Marking

Part No.	Marking
AIC3411GJ6	411

■ ABSOLUTE MAXIMUM RATINGS

Pin Voltage: FB, EN, OUT, VIN	0.3 V to 6V
Pin Voltage: SW	
DC	-0.3 V to 6V
Pulsed < 100ns	
Operating Ambient Temperature Range T _A	
Operating Maximum Junction Temperature T _J	150°C
Storage Temperature Range T _{STG}	65°C to 150°C
Lead Temperature (Soldering 10 Sec.)	260°C
Thermal Resistance Junction to Ambient	300°C/W
(Assume no Ambient Airflow, no Heatsink)	

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT

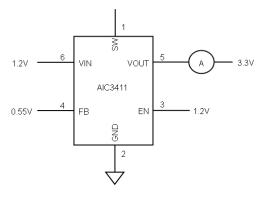


Fig. 2 Test Circuit



■ ELECTRICAL CHARACTERISTICS

(Typical application circuit and the ambient temperature=25°C, V_{IN} =1.2V, V_{OUT} =3.3V, unless otherwise specified)(Note 1)

PARAMETER	TEST CONDITION	SYMBOL	MIN	TYP	MAX	UNIT
Output Voltage Range		V _{OUT}	1.65		5.5	V
Minimum Start Up Voltage	RL= 3.3KOhm			0.7	0.9	V
Input Operation Voltage			0.7		5	V
Under Voltage Lockout of Vin	Vin decreasing	V _{UVLO}		0.5	0.7	V
Quiescent Current (PSM)	V_{IN} =1.2V, V_{OUT} =3.3V, V_{FB} =0.55V (Note 2)	IQ		7.5	12.5	μΑ
IC Shut Down Current	EN = 0V, V _{OUT} =1.1V	I _{SD}		0.01	1.0	μΑ
Feedback Voltage		V _{FB}	490	500	510	mV
FB Input Leakage Current	V _{FB} =1.3V	I _{FB}		1	50	nA
Inductor current ripple		I _{LH}		200		mA
Constant off time	V _{IN} =1.2V, V _{OUT} =3.3V	T _{OFF}		400		ns
Line Regulation	V _{IN} <v<sub>OUT (Note 3)</v<sub>			0.5%		
Load Regulation	V _{IN} <v<sub>OUT (Note 3)</v<sub>			0.5%		
NMOS Switch Leakage	V _{SW} =5V			0.1	5	μΑ
PMOS Switch Leakage	V _{SW} =5V, V _{OUT} =0V			0.1	10	μA
NMOS Switch On Resistance	VIN=1.2V, VOUT=3.3V			400		mΩ
PMOS Switch On Resistance	VIN=1.2V, VOUT=3.3V			800		mΩ
EN High Threshold Voltage	VIN=1.2V		0.8			V
EN Low Threshold Voltage	VIN=1.2V				0.2	V
EN Pin Input Current	EN = 5.5V	I _{SHDN}		0.01	1.0	μΑ
NMOS Current Limit	VIN=1.2V, VOUT=3.3V		0.24	0.4		Α
Over Temperature Protection				140		°C
Over Temperature Hysteresis				20		°C

Note 1: Specifications are production tested at T_A =25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note 2: The test circuit shown in Fig. 2.

Note 3: Guarantee by Design.



■ TYPICAL PERFORMANCE CHARACTERISTICS

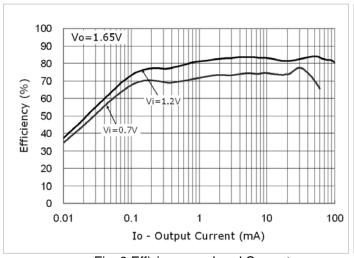


Fig. 3 Efficiency vs. Load Current

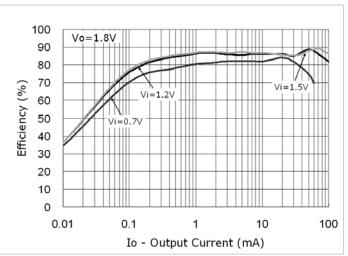


Fig. 4 Efficiency vs. Load Current

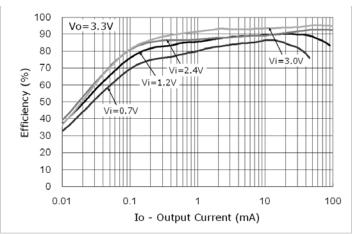


Fig. 5 Efficiency vs. Load Current

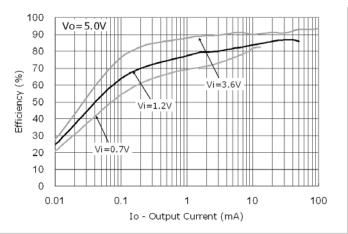


Fig. 6 Efficiency vs. Load Current

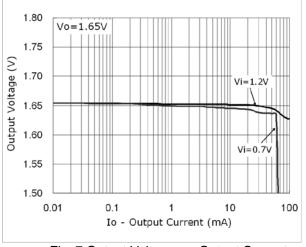


Fig. 7 Output Voltage vs. Output Current

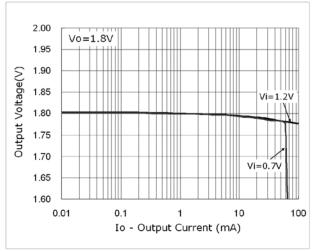


Fig. 8 Output Voltage vs. Output Current



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

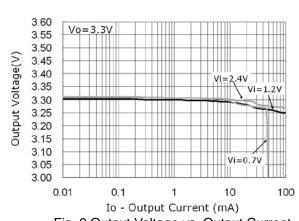


Fig. 9 Output Voltage vs. Output Current

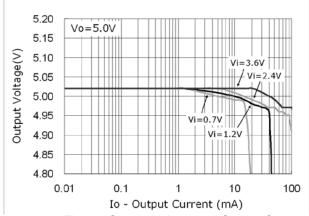


Fig. 10 Output Voltage vs. Output Current

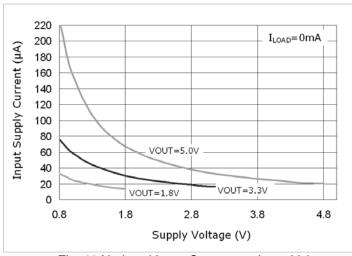


Fig. 11 No Load Input Current vs. Input Voltage

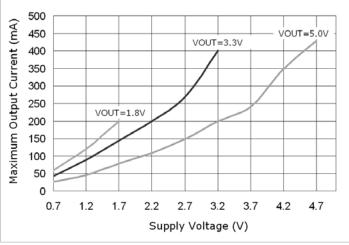


Fig. 12 Maximum Output Current vs. Input Voltage

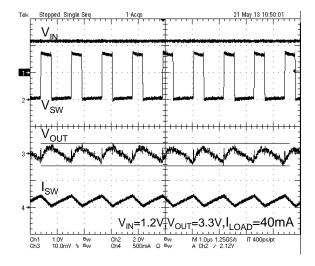


Fig. 13 Switching Waveform

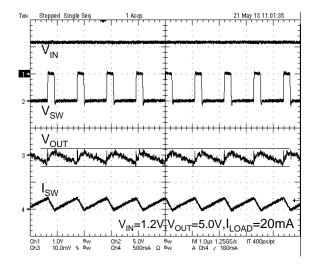


Fig. 14 Switching Waveform



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

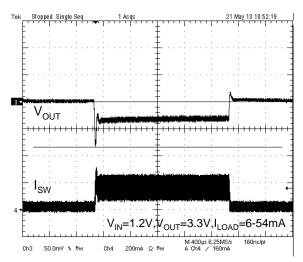


Fig. 15 Load Transient Response

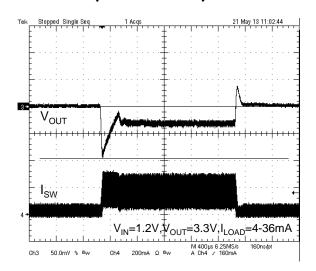
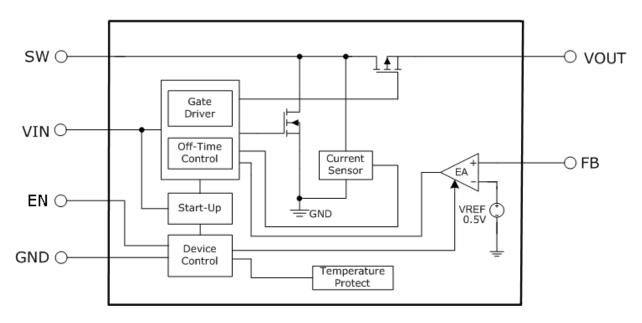


Fig. 16 Load Transient Response



BLOCK DIAGRAM



Functional Block Diagram of AIC3411

■ PIN DESCRIPTIONS

PIN 1: VIN - Input Supply Pin.

PIN 2: FB - Feedback Input to Error Ampli-

fier. Connect resistor divider tap

to this pin.

PIN 3: GND - Signal and Power Ground.

PIN 4: VOUT - Output Voltage Sense and

Drain of the Internal Synchro-

nous Rectifier

PIN 5: SW - Switch Pin. Connect Inductor

between VIN and this pin.

PIN 6: EN - Logic Controlled Shutdown In-

put.

EN= High: Normal Operation.

EN= Low: IC shutdown.



APPLICATION INFORMATION

The AlC3411 is a synchronous step-up DC-DC converter. It is based on constant Off Time/PSM controller topology. At the beginning of each clock cycle, the main switch (NMOS) is turned on and the inductor current starts to ramp. After the sense current signal equals the error amplifier (EA) output, the main switch is turned off and the synchronous switch (PMOS) is turned on. The device can operate with an input voltage below 1V; the typical start-up voltage is 0.7V.

Current Limit

The over current protection is to limit the switch current. The output voltage will be dropped when over current is happened. The current limit amplifier will turn off switch once the current exceeds its threshold.

Zero Current Comparator

The zero current comparator monitors the inductor current to the output and shuts off the synchronous rectifier. This prevents the inductor current from reversing in polarity improving efficiency at light loads.

Device Shutdown

When EN is set logic high, the AlC3411 is put into active mode operation. If EN is set logic low, the device is put into shutdown mode and consumes less than 1μ A of current. At the shutdown mode, the synchronous switch will turn off and the output voltage of AlC3411 step-up converter will reduce to 0V. After start-up, the internal circuitry is supplied by VOUT, however, if shutdown mode is enabled, the internal circuitry will be supplied by the input source again.

Adjustable Output Voltage

An external resistor divider is used to set the output voltage. The output voltage of the switching regulator (V_{OUT}) is determined by the following equation:

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R_1}{R_2}\right)$$

Where V_{FB} is 0.5V reference voltage.

Input Inductor Selection

The inductor values of 4.7 µH can get the good per-

formance over the whole converter ratio cases.

To choose other inductance values by the following equation:

$$L = \frac{(V_{OUT} - V_{IN}) \times 614.07 \times (V_{OUT} - V_{IN})^{-0.3781}}{200 mA} ~~(\mu H)$$

Using inductor values below 2.2 μH is not recommended.

Input Capacitor Selection

Surfaces mount $4.7\mu F$ or greater, X5R or X7R, ceramic capacitor is suggested for the input capacitor. The input capacitor provides a low impedance loop for the edges of pulsed current drawn by the AlC3411. Low ESR/ESL X7R and X5R ceramic capacitors are ideal for this function. To minimize stray inductance, the capacitor should be placed as close as possible to the IC. This keeps the high frequency content of the input current localized, minimizing EMI and input voltage ripple. Always examine the ceramic capacitor DC voltage coefficient characteristics to get the proper value.

Output Capacitor Selection

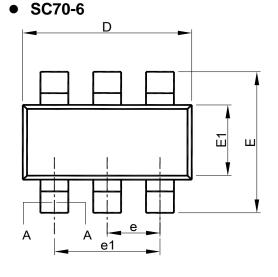
The output capacitor limits the output ripple and provides holdup during large load transitions. A $4.7\mu F$ to $10\mu F$, X5R or X7R, ceramic capacitor is suggested for the output capacitor. Typically the recommended capacitor range provides sufficient bulk capacitance to stabilize the output voltage during large load transitions and has the low ESR and ESL characteristics necessary for low output voltage ripple.

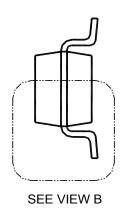
PCB Layout Guidance

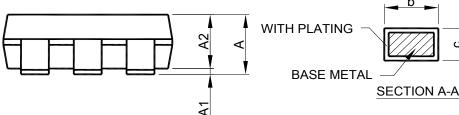
This is a considerably high frequency for DC-DC converters. PCB layout is important to guarantee satisfactory performance. It is recommended to make traces of the power loop, especially where the switching node is involved, as short and wide as possible. First of all, the inductor, input and output capacitor should be as close to the device as possible. Feedback and shutdown circuits should avoid the proximity of large AC signals involving the power inductor and switching node.

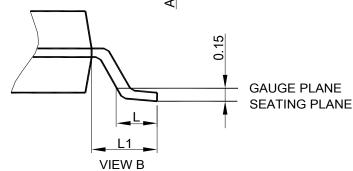


■ PHYSICAL DIMENSIONS









S	SC70-6				
S Y M B	MILLIMETERS				
O L	MIN.	MAX.			
Α	-	1.10			
A1	0	0.10			
A2	0.70	1.00			
b	0.15	0.30			
С	0.08	0.25			
D	1.85	2.15			
Е	1.80	2.40			
E1	1.10	1.40			
е	0.65 BSC				
e1	1.30 BSC				
L	0.26	0.46			
L1	0.42 REF				

Note: 1. Refer to JEDEC MO-203AB.

- 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
- 3. Dimension "E1" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Note:

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